8183

LOW-DROPOUT, 3 V REGULATOR — HIGH EFFICIENCY

Designed specifically to meet the requirement for extended operation of battery-powered equipment such as cordless and cellular telephones, the A8183SLU voltage regulator offers the reduced dropout voltage and quiescent current essential for maximum battery life. Applicable also to palmtop computers and personal data assistants, the device delivers a regulated, continuous 3 V output at up to 75 mA under normal operating conditions, or to 150 mA (transient) under worst-case conditions.

A PMOS pass element provides a typical dropout voltage of only 90 mV at 60 mA of load current. The low dropout voltage permits deeper battery discharge before output regulation is lost. Furthermore, quiescent current does not increase as the dropout voltage is approached, an ideal feature in standby/resume power systems where data integrity is crucial. Regulator accuracy and excellent temperature characteristics are provided by a bandgap reference. An ENABLE input gives the designer complete control over power up, standby, or power down.

This device is supplied in a 6-lead small-outline plastic package (similar to the SOT-89/TO-243AA) for surface-mount applications. The A8183SLU is rated for operation over a temperature range of -20°C to +85°C.

FEATURES AND BENEFITS

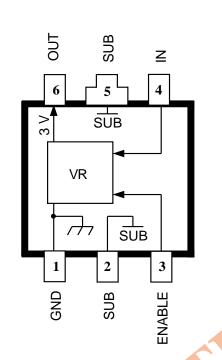
- High Efficiency Provides Extended Battery Life
- 90 mV Typical Dropout Voltage at I_O = 60 mA
- 45 μA Typical Quiescent Current at V_I = 6 V Less Than 1 μA "Sleep" Current
- Up to 150 mA Output Current
- CMOS-Compatible ON/OFF Control For Power-Up, Standby, or Shutdown
- Internal Thermal Protection
- Surface-Mount Package

APPLICATIONS

- Cordless and Cellular Telephones
- Personal Data Assistants
- Personal Communicators
- Palmtop Computers

Always order by complete part number:

A8183SLU

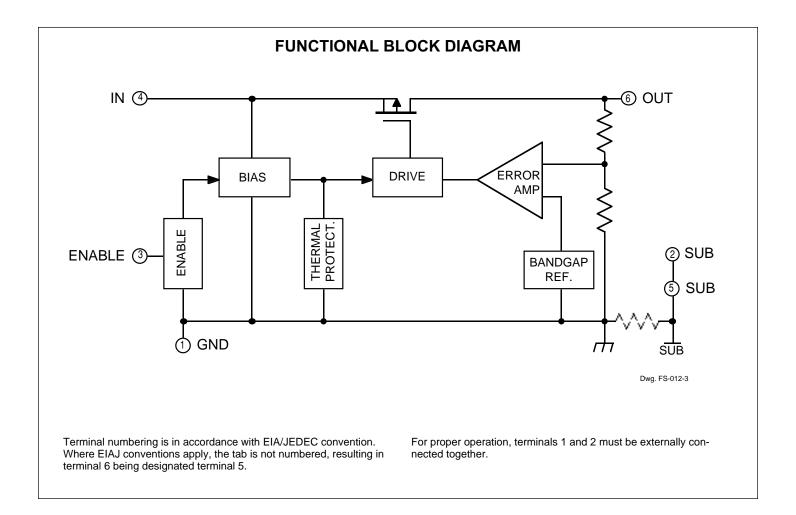


Dwg. PS-021

ABSOLUTE MAXIMUM RATINGS

- * Output current rating is limited by input voltage, duty cycle, and ambient temperature. Under any set of conditions, do not exceed a junction temperature of +150°C. See next page.
- † Fault conditions that produce excessive junction temperature will activate device thermal shutdown circuitry. These conditions can be tolerated but should be avoided.





MAXIMUM ALLOWABLE OUTPUT CURRENT with device mounted on 2.24" x 2.24" (56.9 mm x 56.9 mm) solder-coated copper-clad board in still air.

	Maximum Allowable Output Current in Milliamperes with $V_I = 8 \text{ V}$, $T_J = 150 ^{\circ}\text{C}$, Period $\leq 10 \text{ s}^*$											
	dc (Duty Cycle)											
T _A	100%	90%	80%	70%	60%	50%	40%	30%	20%			
25°C	95	105	120	135	150	150	150	150	150			
50°C	75	85	95	110	125	150	150	150	150			
70°C	60	65	75	85	100	120	150	150	150			
85°C	50	55	60	70	80	100	125	150	150			

^{*} $I_O = (T_J - T_A)/([V_I - V_O] R_{\theta JA} \cdot dc) = (150 - T_A)/(5 \cdot 258 \cdot dc)$

Output current rating can be increased (to 150 mA maximum) by heat sinking or reducing the input voltage. Conditions that produce excessive junction temperature will activate device thermal shutdown circuitry. These conditions can be tolerated but should be avoided.



ELECTRICAL CHARACTERISTICS at $T_A = +25^{\circ}C$ (unless otherwise noted).

				Limits				
Characteristic Symbol Test		Test Conditions	est Conditions			Max.	Units	
Output Voltage	V _o	$4 \text{ V} \leq \text{V}_{\text{I}} \leq 8 \text{ V},$	T _A = +25°C	2.95	3.00	3.05	V	
		10 μA \leq I _O \leq 100 mA*	-20°C ≤ T _A ≤ +85°C	2.90	3.00	3.10	V	
		$V_1 = 3 \text{ V}, I_0 = 60 \text{ mA*}, -20^{\circ}\text{C} \le T_A \le +85^{\circ}\text{C}$		2.70	_	_	V	
Output Volt. Temp. Coeff.	α_{VO}	V _I = 6 V, I _O = 10 mA	_	_	±1.0	mV/°C		
Line Regulation	egulation $\Delta V_{O(\Delta VI)}$ 6 V ≤ V _I ≤ 8 V, I _O = 1 mA		nA	_	4.0	10	mV	
		$4 \text{ V} \le \text{V}_{\text{I}} \le 6 \text{ V}, \text{I}_{\text{O}} = 1 \text{ m}$	nA	_	9.5	18	mV	
Load Regulation	$\Delta V_{O(\Delta IO)}$	1 mA ≤ I _O ≤ 100 mA*,	_	19	30	mV		
		1 mA ≤ I _O ≤ 100 mA*, V _I = 6 V		-	14	25	mV	
		1 mA ≤ I _O ≤ 100 mA*, V _I = 4 V		_	8.0	20	mV	
Dropout Voltage	Dropout Voltage $V_1 \text{min} - V_0 I_0 = 60 \text{ mA}^*$		A*		90	150	mV	
		I _O = 125 mA*		_	190	300	mV	
Quiescent Current	Ι _Q	$V_{I} = 6 \text{ V}, 1 \text{ mA} \le I_{O} \le 100 \text{ mA*}, V_{E} \ge 2.0 \text{ V}$		_	45	60	μΑ	
(GND terminal current)		$V_1 = 8 \text{ V}, 1 \text{ mA} \le I_0 \le 100 \text{ mA*}, V_E \ge 2.0 \text{ V}$		_	50	65	μΑ	
	I _{Q(off)}	$4 \text{ V} \le \text{V}_{\text{I}} \le 8 \text{ V}, \text{ V}_{\text{E}} \le 0.8 \text{ V}$		_	_	1.0	μΑ	
ENABLE Input Voltage	V _{EH}	$4 \text{ V} \leq \text{V}_{\text{I}} \leq 8 \text{ V},$	Output ON	2.0	_	_	V	
	V _{EL}	-20°C ≤ T _A ≤ +85°C	Output OFF	_	_	0.8	V	
ENABLE Input Current	Input Current I_E $T_A \le +85^{\circ}C$, $V_E = V_I = 8 \text{ V}$				_	±0.1	μΑ	
Thermal Shutdown Temp. T _J			150			°C		
Thermal Resistance R _{θJA} Mounted on 2.24" x 2 copper-clad board in			_	258	_	°C/W		

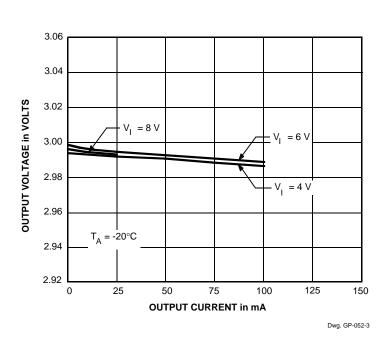
Typical values are at $T_{\rm A}$ = +25°C and are given for circuit design information only.

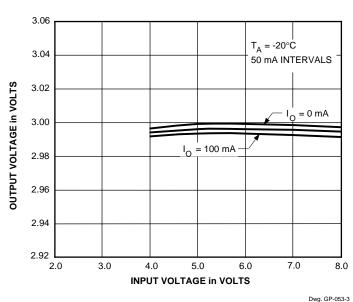
 $^{^{\}star}$ Pulse test ($\!\leq\!20$ ms). See previous page for duty cycle limitations.

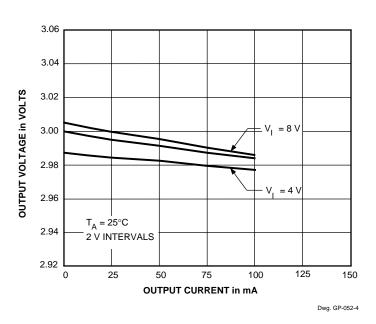
TYPICAL CHARACTERISTICS

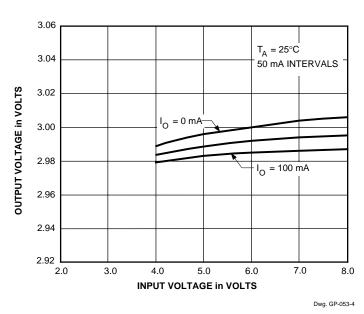
LOAD REGULATION

LINE REGULATION





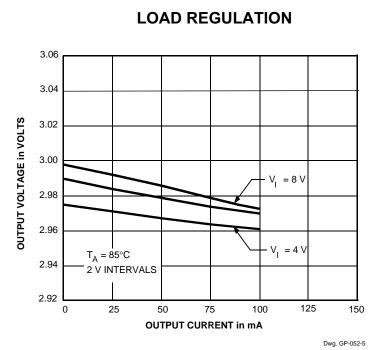




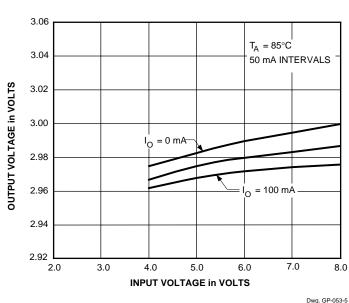
CAUTION: Maximum allowable duty cycle will be significantly less than 100% at high temperatures, at high input voltages, or at high output currents. See Maximum Allowable Output Current table.



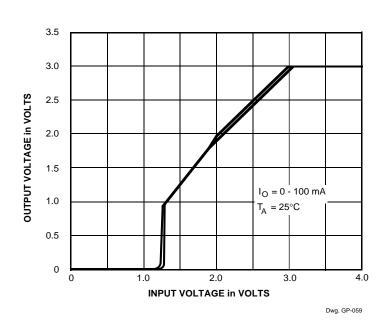
TYPICAL CHARACTERISTICS (cont'd)

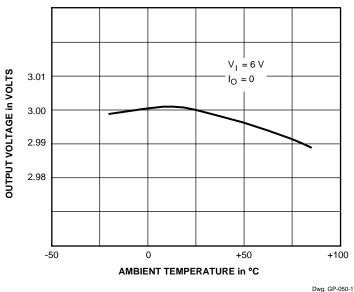


LINE REGULATION



OUTPUT VOLTAGE

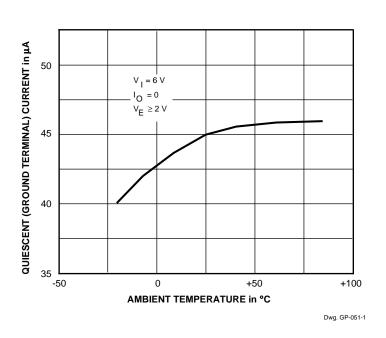


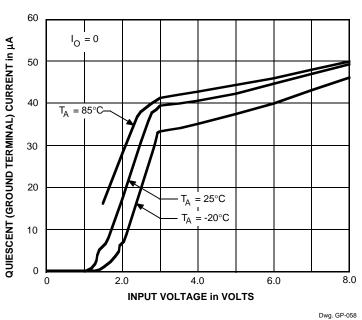


CAUTION: Maximum allowable duty cycle will be significantly less than 100% at high temperatures, at high input voltages, or at high output currents. See Maximum Allowable Output Current table.

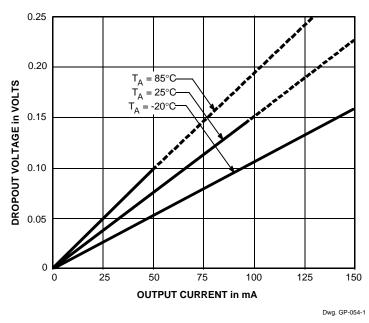
TYPICAL CHARACTERISTICS (cont'd)

QUIESCENT (GROUND TERMINAL) CURRENT





DROPOUT VOLTAGE



CAUTION: Maximum allowable duty cycle will be significantly less than 100% at high temperatures, at high input voltages, or at high output currents. See Maximum Allowable Output Current table.



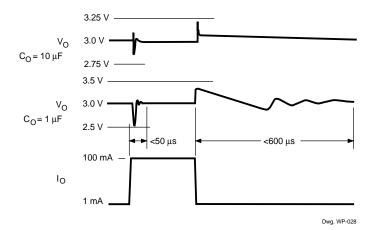
TYPICAL CHARACTERISTICS (concluded)

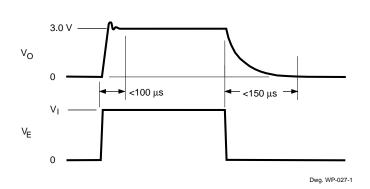
LOAD TRANSIENT PERFORMANCE

 V_I = 3.2 V to 6.2 V, C_O as specified, T_A = 25°C

ENABLE TRANSIENT PERFORMANCE

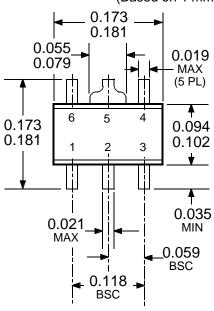
 V_I = 3.2 V to 6.2 V, C_O = 1 μ F, T_A = 25°C

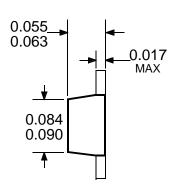




Dimensions in Inches

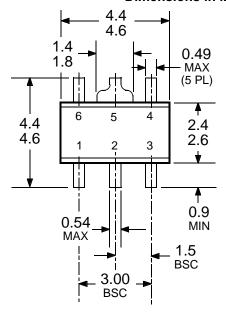
(Based on 1 mm = 0.03937")

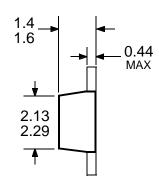




Dwg. MA-009-6 in

Dimensions in Millimeters





Dwg. MA-009-6 mm

NOTES: 1. Lead spacing tolerance is non-cumulative.

- Exact body and lead configuration at vendor's option within limits shown.
- 3. Terminal numbering is in accordance with EIA/JEDEC convention. Where EIAJ conventions apply, the tab is not numbered, resulting in terminal 6 being designated terminal 5.



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